

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Masahiko KAWASE and
Hidenobu KIMOTO.
Divisional Application of Parent Serial No.: 09/690,870
Filing Date: Concurrently herewith
**For: A CHIP-TYPE COMPOSITE ELECTRONIC
COMPONENT AND MANUFACTURING
METHOD THEREOF**

#4/100-
Amended
AND
8/29/02

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination on the merits, please amend the above-identified patent application as follows:

IN THE SPECIFICATION:

On page 1, before the first paragraph, please add the following new paragraph:

This application is a Divisional of U.S. Patent Application No. 09/690,870 filed October 17, 2000, currently pending.

IN THE CLAIMS:

Please cancel Claims 1-8 without prejudice or disclaimer of the subject matter contained therein.

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